

Product Change Notification

PCN#: CIF-P20200701







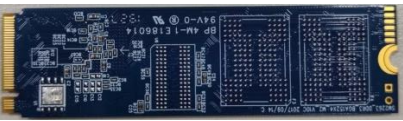

Subject: Product Change Notice for Cervoz Industrial Flash Modules

Product: M.2 2242/2280 NVMe PCIe Gen3x4 Standard Temperature products

Key Characteristics of the Change: The products come with Graphene Heatsink.

Description: Cervoz design new Graphene heatsink for M.2 2242/2280 NVMe PCIe Gen3x4 T405 and T435 Family Standard Temperature products. The Graphene heatsink is able to increase the heat dissipation efficiently, helping the corresponding SSD to operate stably. Moreover, the thickness of the Graphene heatsink is 0.25mm±0.02mm. It is the best design choice on dimension consideration, especially electronic products with a confined space.

Effective Date: 2020.07.01

Form Factor and Family Affected: M.2 2242/2280 T405 and T435 Family Standard Temperature products		
Model Names	Current Products Appearance	New Products Appearance
CIE-M4T4*5M*F****S	Front Side 	Front Side 
	Back Side 	Back Side 
CIE-M8T4*5M*F****S	Front Side 	Front Side 
	Back Side 	Back Side 

Sincerely yours,

Alex Lee.

Product Manager

Product Department

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